



Changshu Talent
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SM12C

Features

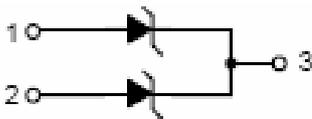
- For sensitive ESD protection
- Stand-off Voltage:12V
- Low leakage
- ESD rating of class 3(>16KV)per Human Body Mode
- Fast response ,response time less than 1ns.
- Lead Free Finish/RoHS Compliant ("P" Suffix designates RoHS Compliant. See ordering information)
- Epoxy meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level 1

Maximum Ratings

- Operating Junction & Storage Temperature: -55°C to +150°C
- Maximum Thermal Resistance: 556°C/W Junction To Ambient

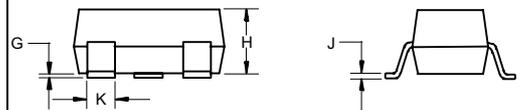
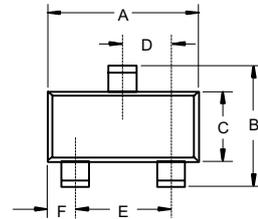
| Parameter | Symbol | Limits | unit |
|--|----------------|-------------|------|
| IEC61000-4-2(ESD) Air Contact | | ± 15 ± 8 | KV |
| ESD Voltage per human body mode | | 16 | KV |
| Power Dissipation | Pd | 225 | mw |
| Lead Solder Temperature-Maximum (10 Second Duration) | T _L | 260 | °C |

Pin Configuration-Top View

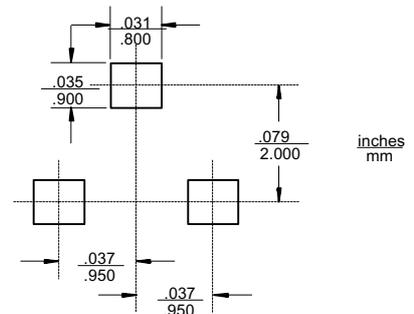


12Volts ESD Protection Devices

SOT-23



| DIM | INCHES | | MM | | NOTE |
|-----|--------|-------|------|------|------|
| | MIN | MAX | MIN | MAX | |
| A | .110 | .120 | 2.80 | 3.04 | |
| B | .083 | .104 | 2.10 | 2.64 | |
| C | .047 | .055 | 1.20 | 1.40 | |
| D | .035 | .041 | .89 | 1.03 | |
| E | .070 | .081 | 1.78 | 2.05 | |
| F | .018 | .024 | .45 | .60 | |
| G | .0005 | .0039 | .013 | .100 | |
| H | .035 | .044 | .89 | 1.12 | |
| J | .003 | .007 | .085 | .180 | |
| K | .015 | .020 | .37 | .51 | |

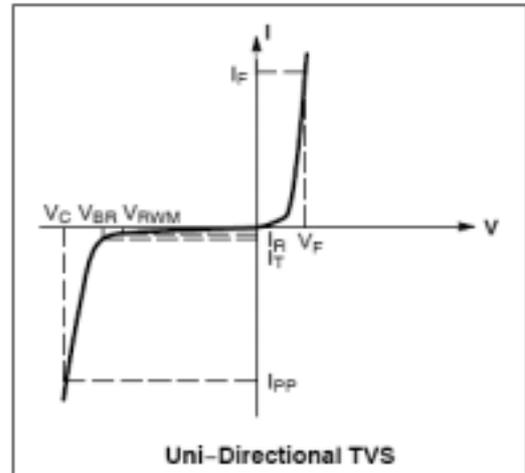




ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

UNIDIRECTIONAL (Circuit tied to Pins 1 and 3 or 2 and 3)

| Symbol | Parameter |
|-----------|---|
| I_{PP} | Maximum Reverse Peak Pulse Current |
| V_C | Clamping Voltage @ I_{PP} |
| V_{RWM} | Working Peak Reverse Voltage |
| I_R | Maximum Reverse Leakage Current @ V_{RWM} |
| V_{BR} | Breakdown Voltage @ I_T |
| I_T | Test Current |
| I_F | Forward Current |
| V_F | Forward Voltage @ I_F |
| P_{pk} | Peak Power Dissipation |
| C | Capacitance @ $V_R=0$ and $f=1\text{MHz}$ |



ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted, $V_f = 0.9\text{ V Max.}$ @ $I_f = 10\text{mA}$ for all types)

| Device | Device Marking | V_{RWM} (V) | I_R (μA) @ V_{RWM} | V_{BR} (V) @ I_T (Note 2) | | I_T | V_C @ $I_{PP}=1\text{ A}$ | Max I_{PP}^+ | P_{pk}^+ (W) | C (pF) Pin 1 to 3 |
|--------|----------------|---------------|--|----------------------------------|-------|-------|--------------------------------|----------------|----------------|----------------------|
| | | Max | Max | Min | Max | mA | V | A | Max | Typ |
| SM12C | 12L | 12 | 1.0 | 13.3 | 15.75 | 1.0 | 19 | 11.2 | 300 | 95 |

+Surge current waveform per Figure 3

2. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C .



TYPICAL CHARACTERISTICS

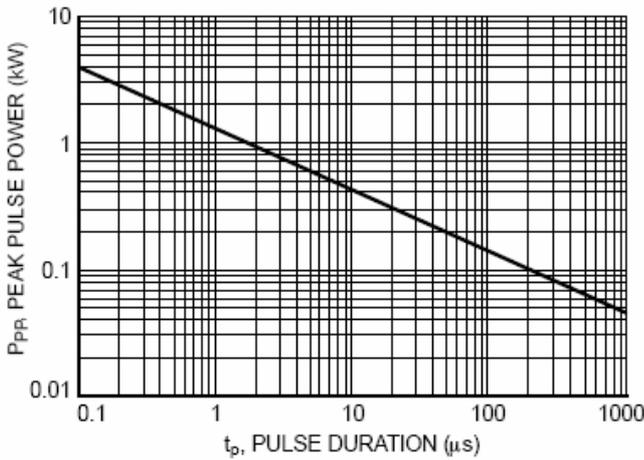


Figure 1. Non-Repetitive Peak Pulse Power versus Pulse Time

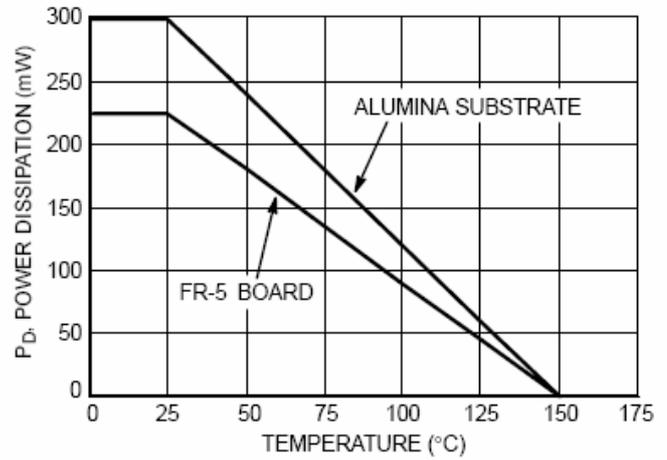


Figure 2. Steady State Power Derating Curve

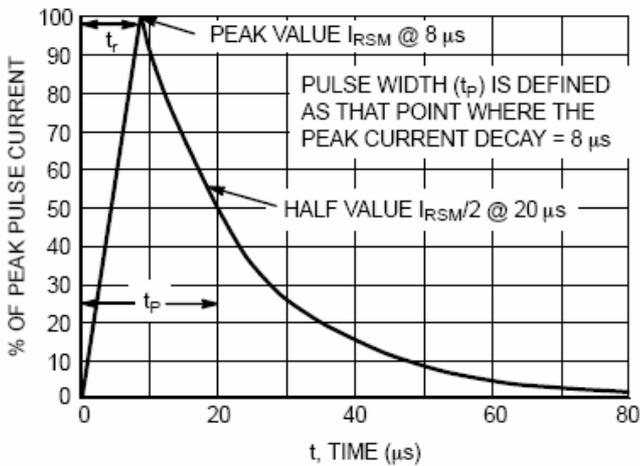


Figure 3. 8 × 20 μs Pulse Waveform

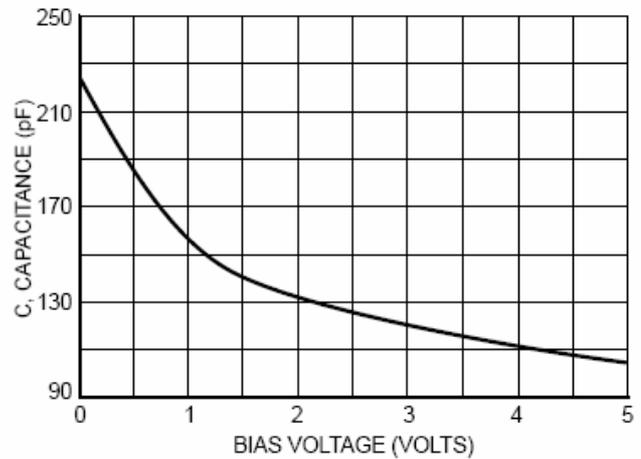


Figure 4. Typical Diode Capacitance